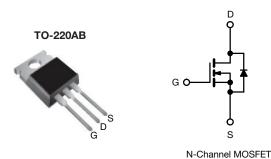
COMPLIANT

HALOGEN

FREE



# **E Series Power MOSFET**



PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	550			
R <sub>DS(on)</sub> max. at 25 °C (Ω)	V <sub>GS</sub> = 10 V	0.243		
Q <sub>g</sub> max. (nC)	66			
Q <sub>gs</sub> (nC)	8			
Q <sub>gd</sub> (nC)	14			
Configuration	Single			

### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qq
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

## **APPLICATIONS**

- Computing
  - PC silver box / ATX power supplies
- Lighting
  - Two stage LED lighting
- · Consumer electronics
- · Applications using hard switched topologies
  - Power factor correction (PFC)
  - Two switch forward converter
  - Flyback converter
- Switch mode power supplies (SMPS)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP15N50E-BE3 <sup>a</sup>
	SiHP15N50E-GE3

### Note

a. "-BE3" denotes alternate manufacturing location

ABSOLUTE MAXIMUM RATINGS	$\Gamma_{\rm C} = 25$ °C, un	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			$V_{DS}$	500	.,
Gate-Source Voltage			$V_{GS}$	± 30	_ v
Continuous Drain Current (T <sub>J</sub> = 150 °C)	V -+ 10 V	$T_{\rm C} = 25  ^{\circ}{\rm C}$ $T_{\rm C} = 100  ^{\circ}{\rm C}$	- I <sub>D</sub>	14.5	
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		9.2	Α
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	28	
Linear Derating Factor				1.25	W/°C
Single Pulse Avalanche Energy b			E <sub>AS</sub>	136	mJ
Maximum Power Dissipation			$P_{D}$	156	W
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-Source Voltage Slope	$V_{DS} = 0 V t$	$V_{DS} = 0 \text{ V to } 80 \% V_{DS}$		70	1//
Reverse Diode dV/dt d			dV/dt	27	- V/ns
Soldering Recommendations (Peak Temperature	e) <sup>c</sup> for	for 10 s		300	°C

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 3.1 A
- c. 1.6 mm from case
- d.  $I_{SD} \le I_D$ ,  $dI/dt = 100 \text{ A/}\mu\text{s}$ , starting  $T_J = 25 \,^{\circ}\text{C}$



Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R <sub>thJA</sub>	-	62	°C/W	
Maximum junction-to-case (drain)	$R_{thJC}$	-	0.8	G/VV	

PARAMETER	SYMBOL	TES	TEST CONDITIONS			MAX.	UNIT
Static					•	·	
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, I <sub>D</sub> = 1 mA		0.62	-	V/°C
Gate-source threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		-	4.0	V
		$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	,	$V_{GS} = \pm 30 \text{ V}$		-	± 1	μΑ
Zana anto coltano durin accument		V <sub>DS</sub> =	$V_{DS} = 500 \text{ V}, V_{GS} = 0 \text{ V}$		-	10	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 400 V	, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	25	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 7.5 A	-	0.243	0.280	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	= 30 V, I <sub>D</sub> = 7.5 A	-	3.9	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ f = 1  MHz		-	1162	-	pF
Output capacitance	C <sub>oss</sub>			-	51	-	
Reverse transfer capacitance	C <sub>rss</sub>			-	7	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	V <sub>DS</sub> = 0 V to 400 V, V <sub>GS</sub> = 0 V		-	55	-	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	164	-	
Total gate charge	Qg			-	33	66	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 7.5 \text{ A}, V_{DS} = 400 \text{ V}$		8	-	nC
Gate-drain charge	Q <sub>gd</sub>			-	14	-	1
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DD</sub> = 400 V, I <sub>D</sub> = 12 A,		-	15	30	ns ns
Rise time	t <sub>r</sub>			-	24	48	
Turn-off delay time	t <sub>d(off)</sub>	V <sub>GS</sub> =	$V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		34	68	
Fall time	t <sub>f</sub>				18	36	
Gate input resistance	$R_g$	f = 1 MHz, open drain		-	0.85	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	14.5	
Pulsed diode forward current	I <sub>SM</sub>			-	-	28	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 7.5 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = I <sub>S = 7.5 A</sub> , dI/dt = 100 A/ $\mu$ s. $V_R$ = 25 V		-	265	-	ns
Reverse recovery charge	Q <sub>rr</sub>			-	3.2	-	μC
Reverse recovery current	I <sub>RRM</sub>			-	23	-	A

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$  b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

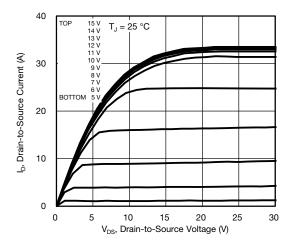


Fig. 1 - Typical Output Characteristics

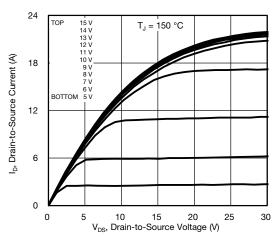


Fig. 2 - Typical Output Characteristics

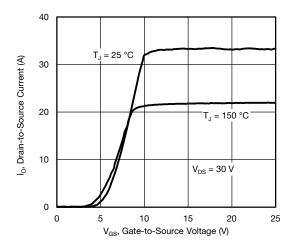


Fig. 3 - Typical Transfer Characteristics

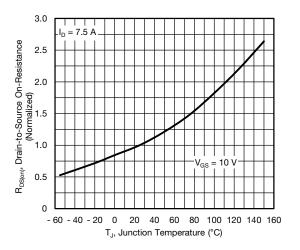


Fig. 4 - Normalized On-Resistance vs. Temperature

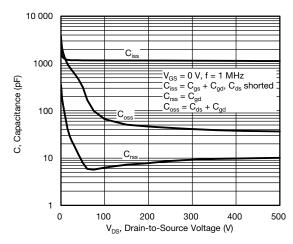


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

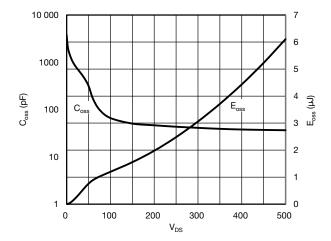


Fig. 6 - Coss and Eoss vs. VDS



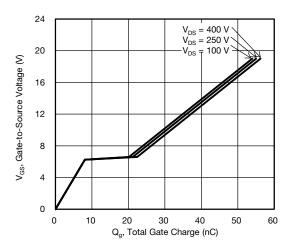


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

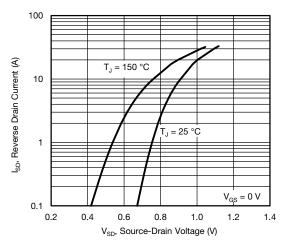


Fig. 8 - Typical Source-Drain Diode Forward Voltage

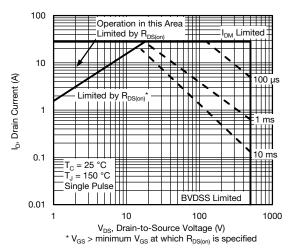


Fig. 9 - Maximum Safe Operating Area

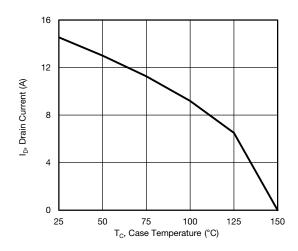


Fig. 10 - Maximum Drain Current vs. Case Temperature

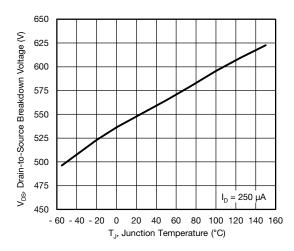


Fig. 11 - Temperature vs. Drain-to-Source Voltage



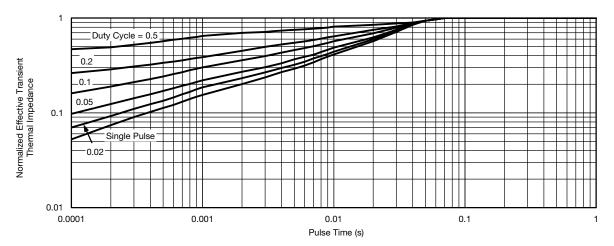


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

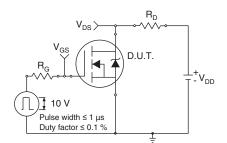


Fig. 13 - Switching Time Test Circuit

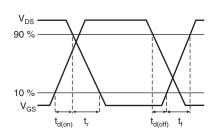


Fig. 14 - Switching Time Waveforms

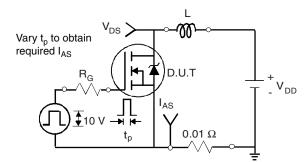


Fig. 15 - Unclamped Inductive Test Circuit

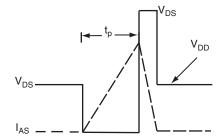


Fig. 16 - Unclamped Inductive Waveforms

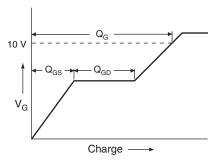


Fig. 17 - Basic Gate Charge Waveform

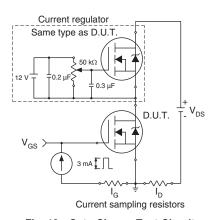
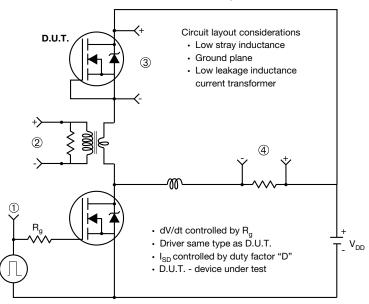


Fig. 18 - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



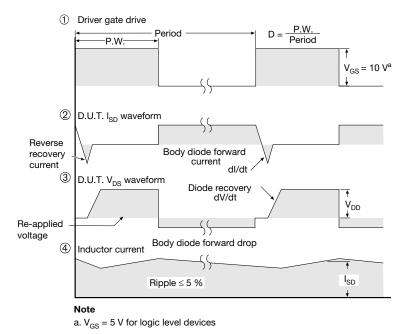


Fig. 19 - For N-Channel

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